Fiber Optic Vacuum Ultraviolet Sensor Based on an AlN-Microwire Probe

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Abstract: Vacuum ultraviolet (VUV) light sensing shows great potential applications in the space science, materials, biophysics, and plasma physics. In this work, an all-optical detection method is proposed for VUV sensing by constructing an optical fiber-end Fabry-Pérot interferometer based on a single aluminum nitride (AlN) microwire. Compared with the traditional electrical devices, this all-optical detection method overcomes the difficulties like the fast response and electromagnetic interference immunity in detecting VUV bands at the present stage, and improves the response speed. The proposed device shows the excellent performance of VUV detection, with the static sensitivity of 1.03 nm/(W·cm⁻²), response rise time of down to 10 μ s, and decay time of 0.64 ms. Beneficial from the excellent radiation resistance of AlN microwires and UV resistance of silica fibers, the proposed device is expected to have the good stability and potential applications in the fields of the solar physics and space exploration.

Keywords: Optical fiber sensor; VUV; Fabry-Pérot interferometer; UV sensing

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1. Introduction

Vacuum ultraviolet (VUV) sensing is of great significance in the fields of the solar physics, space science, semiconductor industry, and biopharmaceutical and basic science [1–10]. For example, due to the fact of significant differences in the VUV region of the solar spectrum during intense solar activities, the VUV sensing technology is considered to be an extremely effective method to monitor the solar wind, track the evolution of stars, and predict the space weather [11, 12]. In the field of the semiconductor industry, the high-performance VUV sensing technology is also very important for high-resolution lithography such as 193 nm and 157 nm excimer laser lithography and 13.5 nm extreme ultraviolet (EUV) lithography, where the VUV sensing technology with the excellent

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performance is needed to monitor the single pulse energy with the high accuracy in real time [13]. In basic sciences, VUV is widely used in the fields of high-energy physics, nonlinear optics, spectroscopy, surface physics, photochemistry, and so on [14]. The inherent requirements of this cutting-edge science have become an important driving force for the development of the high-performance VUV sensing technology.

The VUV light-band spans from 10 nm to 200 nm, which will be strongly absorbed by atoms and molecules of oxygen in the air and can only propagate in vacuum [15]. Limited by the environment and propagation the lack of VUV-related devices and technologies, the VUV sensing technology is still difficult to be widely studied. Critical requirements inspired by extreme environment applications further pose special physical and technical challenges to VUV sensing; for example, the VUV sensor should exhibit high radiation hardness (i.e., no apparent degradation in the presence of high-energy particle radiation), a low noise level, and a high signal-to-noise ratio (SNR) to signal detection, realize weak besides the requirement of the clean and high vacuum working environment [16]. In order to meet these challenges, many types of VUV sensing schemes have been investigated, such as the scintillator, photomultiplier, gas sensing, and semiconductor photodetector [17–21]. The scintillator visualizes the invisible VUV light through the optical down-conversion process and then realizes the VUV sensing combined with the "visible" band light detector or ultrafast camera, of which the system is commonly bulky and complex [17]. The VUV photomultiplier shows the ultra-high sensitivity and ultra-low noise through the external photoelectric effect and photoelectron multiplication process, which has become an excellent device for weak VUV signal sensing [18]. However, the performance of the device depends heavily on window materials (namely, the optical filter) and is not suitable for intense light operation [19]. The gas sensing technology takes gas as the working medium, producing plasmas and outputting electrical signals on the electrode after being irradiated by VUV light, which shows the high stability and long service life [20]. However, it generally only meets the demand of ultra-high power VUV radiation, the working voltage is very high, and the weight and volume are huge. To date, VUV sensing using the internal photoelectric effect of semiconductors, especially the ultra-wide band-gap (UWBG) semiconductor, is an emerging technology with attractive prospects [21]. The energy of 200 nm VUV photons (~6.2 eV) is close to the band-gap of some UWBG semiconductors [such as the aluminum nitride (AlN), BN, and diamond], thus UWBG semiconductors are excellent candidates for developing filterless VUV sensors. Besides the inherent excellent radiation hardness, they also exhibit the advantages of miniaturization and flexibility of integration.

The AlN is one of the important UWBG semiconductors, which exhibits the large direct band-gap (6.28 eV), high physical and chemical stability, high thermal conductivity, low thermal expansion, and excellent radiation hardness. Recently, the low-dimensional single-crystal AlN has been proven to be an ideal material for VUV sensing. For example, W. Zheng et al. [22] reported a VUV sensitive photodetector based on a high-quality single-crystal AlN micro/nanowire, with the response time of 0.1 s for 193 nm ultraviolet (UV) radiation. T. T. Li et al. [23] reported an AlN single-crystal film with the low defect density for VUV sensing, which exhibited the response time of 2.8 µs and decay time of 0.77 ms for 185 nm UV radiation. Up to now, the design of AIN VUV sensors generally employs the mechanism of the photovoltaic effect, photoconductivity gain, or avalanche ionization caused by the photo-generated carriers. However, the carrier mobility and high resistance always limit the sensing performance of the device on the time scale. Meanwhile, the metal

electrodes are prone to damage and reduce the device life under long-term VUV exposure. To solve these problems, here we propose an AlN-microwire based fiber optic device for fast and efficient VUV sensing, where the optical refractive index (RI) of the AlN microwire that changes transiently with the generation of photo-generated carriers is employed for the sensor design to improve the device response time and avoid the VUV damage to the external circuit [24]. For the realization of the proposed fiber optic sensor, an AlN microwire with a length of 210 μ m and a diameter of 5 μ m is integrated on the end-facet of a single mode fiber. Two end-facets of the AlN microwire can reflect the monitoring light delivered from the fiber core and form a fiber-tip Fabry-Pérot interferometer (FPI). Under VUV radiation, photo-generated carriers modify the RI of the AlN microwire as well as the optical path length of the FP interferometer, which will result in the inference wavelength shift on the device reflection spectrum. Experimental results show that the proposed fiber optic VUV sensor achieves the sensitivity of 1.033 nm/(W·cm⁻²), response time of 10 µs, and decay time of 0.64 ms, respectively. Compared to that of the traditional VUV sensing technology, the proposed sensor exhibits the advantage of fast response, filter independence, miniaturization, light weight, and flexibility of deployment (benefitting from the flexible fiber optical path), which provides the great convenience for practical applications in many fields such as cosmology, astrophysics, high energy physics, semiconductor industry, and spectroscopy.

2. Materials and device fabrication

2.1 Preparation and characterization of AlN microwires

AlN microwires are prepared by the physical vapor transport method through necessary hightemperature growth and annealing processes. Figure 1(a) shows the typical scanning electron microscopy (SEM) image of a single AlN microwire with a hexagonal structure. The X-ray diffraction (XRD) result is shown in Fig. 1(b), which is in high consistency compared to that of the standard AIN card, indicating that there are no apparent impurities induced in the synthesis process. The main diffraction peak of the XRD pattern corresponds to the (101) plane of the AlN microwire, and the narrow full-width at half-maximum of all the diffraction orders confirms that the obtained AlN microwire has the good crystal quality. Note that the peaks corresponding to polycrystals in Fig. 1(b) are originated from the testing method that employs a lot of microwires. Figure 1(c) depicts the high-resolution transmission electron microscopy (TEM) image of the AlN microwire, where the spacing distance between the (0001) and (0002) planes can be measured to be 0.493 nm and 0.239 nm, respectively, indicating the good crystallinity and growth direction along the (0001) direction of the synthesized AlN microwires. Note that the upper-right inset is the selected-area electron diffraction (SAED) pattern, which also proves that the AlN microwire is the single crystal, and the calculated inter-planar spacing is the same as that obtained from the TEM image. Energy-dispersive X-ray (EDX) analysis is further used to examine the elemental composition of AlN microwires and the results are shown in Figs. 1(d) and 1(e), respectively, where the distribution of N and Al can be seen clearly. Figure 1(f) shows the Raman spectrum of the synthesized AlN microwire, where 6 phonon modes of A₁(TO), A₁(LO), E₁(TO), E₁(LO), E₂₁, and E_{22} can be observed clearly at 623 cm⁻¹, 891 cm⁻¹, 669 cm^{-1} , 909 cm^{-1} , 247 cm^{-1} , and 656 cm^{-1} , respectively, which further indicates that the AIN microwire has a hexagonal wurtzite crystal structure. The abovementioned results confirm that the synthesized material is high-quality single-crystal AIN microwires.



Fig. 1 Morphology and structural characterization of an AlN microwire: (a) typical SEM image of a single AlN microwire, (b) XRD pattern of AlN microwires, (c) TEM image of a single AlN microwir (the upper-right inset provides the SAED pattern), (d) EDX elemental mapping image of N in a single AlN microwire, (e) EDX elemental mapping image of Al in a single AlN microwire, and (f) scattered Raman spectrum of a single AlN microwire, including all Raman phonon modes in the wurtzite AlN structure.

2.2 Operation principle and sensor fabrication

Figure 2(a) shows the schematic diagram of VUV sensing with an optical fiber sensor probe, where the sensor is an AlN microwire based FPI (AIN-FPI) that is integrated in a fiber-tip. Light is delivered by the optical fiber couples into the AlN microwire and reflected back into the fiber by the two end-facets of the microwire, thus forming a fiber-tip FPI. Under VUV illumination, the RI of the AlN microwire changes due to the carrier generation, which will lead to the interference wavelength shift of the AlN-FPI. As illustrated in Fig. 2(b), the preparation of the AlN-FPI fiber probe includes three steps. Firstly, a commercial single-mode fiber with а core/cladding diameter (SMF) of $8.2 \,\mu\text{m}/125 \,\mu\text{m}$ and a length of $1.5 \,\text{m}$ is fusion spliced to a silica glass tube with an inner/outer diameter of $9 \,\mu\text{m}/125 \,\mu\text{m}$ and a length of about $50 \,\mu\text{m}$ at one end, leaving the other end connected to the light source or optical testing system. The fabricated SMF fiber end is placed in the field of view of the microscope of a computer-controlled manipulation system. Then, a single AlN microwire with the proper diameter and length is picked up by

the tungsten probe of the manipulation system, both ends of which have been flattened by focused ion beam (FIB) milling to improve the end-face reflectivity and the contact between the microwire and fiber core. Finally, the selected AlN microwire is transferred into the glass tube by carefully moving the tungsten probe of the manipulation system, so that one end of the microwire is tightly attached to the fiber core.

Figure 2(c) shows the experimental setup of VUV sensing for the proposed optical fiber sensor. The device is connected to a super-continuum light source (WhiteLase Micro, NKT Photonics) and an optical spectrum analyzer (OSA, AQ6370C, Yokogawa) through a 3-port optical circulator. Light delivered from the light source is reflected by the AIN-FPI and collected by the OSA, which displays the reflected interference spectrum in real time. The VUV laser beam or pumping light with other wavelengths can be focused onto the sensing probe (namely, AIN-FPI) through a proper lens. The sensitivity can be determined by tracing the interference wavelength shift of the AIN-FPI with the average light intensity increasing.



Fig. 2 Illustrations of the device structure, preparation flowchart, and sensitivity test system of the proposed VUV sensor: (a) schematic diagram of the proposed fiber-tip AIN-FPI for VUV sensing, (b) preparation flow chart, and (c) VUV sensitivity measurement system of the fiber-tip AIN-FPI. Note that lasers with the wavelengths of 193 nm, 257 nm, 514 nm, and 908 nm are used here subsequently, and the focusing lens should be replaced accordingly.

3. Results and discussion

Figure 3(a) depicts the reflection spectrum of the proposed fiber-tip AIN-FPI, of which the length L of the AlN microwire is 210 µm, and the free spectral range (FSR) is 2.36 nm around 1 560 nm. The FSR measured from Fig. 3(a) is in good agreement with that obtained from the theoretical estimation, FSR= $\lambda^2/2nL$, where λ is the interference wavelength and n is the RI of the AlN material. The reflection spectrum evolution of the fabricated fiber-tip AlN-FPI under 193 nm VUV irradiation is plotted in Fig. 3(b). As the light intensity gradually increases from $0 \text{ W} \cdot \text{cm}^{-2}$ to $0.486 \text{ W} \cdot \text{cm}^{-2}$, the interference dip at around 1550 nm moves from 1548.64 nm to longer wavelengths, with a total wavelength shift of 1.66 nm. This phenomenon can be attributed to an increase in the RI of the AlN microwire, which is caused by the generation of photocarriers. When the energy of incident photons is higher than the absorption threshold of the AlN semiconductor, valence electrons will transition from the valence band to the conduction band, forming photogenerated electrons and holes. The existence of a large number of photo-generated carriers will cause a detectable change in the absorption coefficient of the material. It can be known from the Kramers-Kronig relationship (K-K relationship) that the change in the absorption coefficient will induce a

measurable change of the material RI. The K-K relationship is given by the following formula [25]:

$$\Delta n(N,P,E) = \frac{2c\hbar}{e^2} P \int_0^\infty \frac{\Delta \alpha(n,p,E')}{E'^2 - E^2} dE' \qquad (1)$$

where *N* and *P* are the concentrations of free electrons and holes, respectively. The terms $\Delta \alpha$, *c*, *e*, *E*, and \hbar are the changes in the absorption coefficient, the speed of light, the electron charge, the photon energy, and Planck's constant, respectively, and *P* \int is the principal value integral. Depending on the carrier concentration, there is a competitive relationship between the band-gap filling effect and the band-gap shrinking effect, one of which is dominant and the other is suppressed. For UWBG semiconductors, the band-gap shrinkage effect will dominate the process when the concentration of photocarriers is at a high level. Regarding the band-gap shrinkage, Bennett *et al.* [26] proposed a parabolic model:

$$\Delta \alpha(\chi, E) = \frac{C}{E} \sqrt{E - E_g - \Delta E_g(\chi)} - \frac{C}{E} \sqrt{E - E_g}$$
(2)

where χ is the concentration of free electrons or holes, and *C* is a constant. Since $\Delta E_g(\chi) < 0$, $\Delta \alpha$ is always positive. Substituting (2) into (1), one can deduce that Δn is always positive. Therefore, the RI of the AlN microwire increases with the VUV light intensity increasing, resulting in the interference wavelength shift towards longer wavelengths.



Fig. 3 Reflection spectrum and VUV-induced interference wavelength shift of the proposed sensor: (a) reflection spectrum of a fiber-tip AlN-FPI sensor with a microwire length of 210 μ m and an FSR of 2.36 nm and (b) reflection spectrum evolution of the fabricated device under 193 nm VUV light irradiation.

Figure 4 describes the relationship between the interference wavelength and light intensity of the proposed VUV sensor for pump wavelengths at 193 nm, 257 nm, 514 nm, and 980 nm. Under VUV illumination, the 193 nm interference wavelength of the AlN-FPI shifts linearly toward long wavelengths with VUV intensity increasing. The sensitivity can be determined to be $1.03 \text{ nm/(W \cdot cm^{-2})}$ through linear fitting. To verify the wavelength selectivity, the proposed AlN-FPI device is exposed to the irradiation of the solar-blind ultraviolet (SBUV, 257 nm), visible (VIS, 514 nm), and near-infrared (NIR, 980 nm) laser beams, respectively. As can be seen clearly from Fig. 4, the sensitivity drops to 2.07 pm/($W \cdot cm^{-2}$) in the case of SBUV irradiation and nearly down to zero in the cases of VIS and NIR irradiation, respectively, which means that the proposed device is only sensitive to VUV. Note that the sensitivity under SBUV irradiation, which is nearly three orders of magnitude lower than that of VUV, is mainly originated from the two-photon absorption (TPA) induced photocarrier generation. This is because the SBUV used here is femtosecond laser pulses, which can provide extremely high peak power to induce TPA processes. Actually, the relationship between the interference wavelength and SBUV intensity is a quadratic function, as shown in the lower inset of Fig. 4, which further proves the existence of the TPA process because the photocarrier density generated through the TPA process is proportional to the square of the incident light intensity. The sensitivity of the proposed sensor under the exposure of 514 nm and 980 nm lasers drops down to $1.91 \times 10^{-7} \text{ nm/(W \cdot cm^{-2})}$ dramatically 9.87×10^{-6} nm/(W·cm⁻²), respectively. The and insensitivity of the proposed AlN-FPI to VIS and NIR indicates that there is no apparent photothermal effect besides the non-absorption of the AlN microwire in the VIS and NIR bands, meaning that the proposed device indeed does not require extra optical filters.



Fig. 4 Relationship between the sensitivity and illumination wavelength for the proposed VUV sensor. Insets show the interference wavelength shift versus light intensities of 193 nm and 257 nm, respectively.

The dynamic response of the proposed VUV sensor is also evaluated according to the edge filtering method with a measurement system as shown in Fig. 5(a) [27], where the super-continuum light source and OSA in Fig. 2(c) are replaced by a single-frequency tunable laser (Model 81940A, Agilent Technologies) and a photodetector (PD, Model 2053, New Focus) that connect to an oscilloscope (MDO 3054, Tektronix), respectively. The excitation VUV pulses used here are generated from a 50 Hz ArF excimer laser with a central wavelength of 193 nm and a pulse duration of 10 ns, and the on-target light intensity is $0.34 \text{ mW} \cdot \text{cm}^{-2}$. The temporal response of the proposed device to 4 laser pulses is depicted in Fig. 5(b), which shows the good stability and fast response. Here, we define the response time of the device to be the duration taken by a signal to change from 10% to 90% between its low and high levels, and vice versa. The magnification of a single-pulse response is shown in Figs. 5(c) and 5(d) to show the rising edge and decay edge, respectively. The rise time (τ_{on}) and decay time (τ_{off}) are measured to be ~10 µs and 0.624 ms, respectively, according to the curves of the rising and decaying edges for 10 successive pulses. Compared with the conventional electric-based photodetectors VUV previously reported, the fiber-optic VUV sensor proposed here exhibits the faster response speed, as listed in Table 1. This is beneficial from the employing of RI changes other than the photocurrent induced by photocarriers in the AlN microwire. The main reason for the slow decay time may possibly originate from the existence of trapped holes (with extended lifetime) and the adsorption of oxygen on AlN surfaces, which may prolong the decay time dramatically [28].



Fig. 5 Temporal response of the proposed VUV sensor: (a) experimental setup for the temporal response measurement of the fiber optic VUV sensor, (b) temporal response of the fiber-tip AlN-FPI under the excitation of 4 successive pulses with a 50 Hz, 193 nm, and 10 ns pulsed VUV laser, (c) magnification of the rising edge, and (d) decaying edge of a single pulse.

PD	Λ (nm)	Responsivity/sensitivity	$ au_{ m on}$	$ au_{ m off}$	Ref
p-Gr/AlN/n-ZnO	185	$0.04 \mathrm{A} \cdot \mathrm{W}^{-1}$	4.2 μs	1 ms	[29]
AlN micro/nanowire	190	$0.39 \ \mathrm{A} \cdot \mathrm{W}^{-1}$	<0.1 s	<0.2 s	[22]
cBN films	180	$0.032 \mathrm{A} \cdot \mathrm{W}^{-1}$	_	_	[30]
AlN film	190	$0.004 5 \text{ A} \cdot \text{W}^{-1}$	<8 s	<3 s	[31]
p-Gr/AlN/n-GaN	185	$0.029 5 \text{ A} \cdot \text{W}^{-1}$	2.8 μs	0.77 ms	[23]
Diamond	58.4	_	4 s	—	[32]
MgO	150	$1.86 \text{ A} \cdot \text{W}^{-1}$	1 s	1 s	[33]
Lamellar AlN	193	5.77 $\mathbf{A} \cdot \mathbf{W}^{-1}$	1.8 ms	63.49 ms	[34]
AlN microwire	193	$1.03 \text{ nm} (\text{W} \cdot \text{cm}^{-2})^{-1}$	<10 µs	0.64 ms	This work

Table 1 Comparisons of different typical semiconductor-based VUV photodetectors.

4. Conclusions

In summary, a fiber-optic VUV sensor based on an AlN microwire constructed FPI is proposed and demonstrated experimentally. The device shows the excellent performance of VUV sensing with the sensitivity of 1.03 nm/($W \cdot cm^{-2}$), rise time of 10 µs, and decay time of 0.64 ms. Compared with the conventional electric VUV detectors, the proposed filterless AlN-FPI device shows the advantages of the fast response, compact size, electromagnetic interference immunity, and radiation resistance in the harsh environment. Benefitting from these features, the proposed sensor is expected to have potential application prospects in the fields of solar physics and space exploration.

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Declarations

Conflict of Interest Yiping Wang is an editorial board

member for Photonic Sensors and was not involved in the editorial review, or the decision to publish this article. All authors declare that there are no competing interests.

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